

# SMB1N-395V-02

- UV High Power LED
- 395 nm, 750 mW
- SMD package, PA9T
- Dimension: 5.0 x 5.2 x 5.5 mm
- Viewing Angle: 22°

## Description





v 1.0 08.07.2014

SMB1N-395V-02 is a surface mount AllnGaN High Power LED with a typical peak wavelength of 395 nm and radiation of 750 mW. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and molded with silicone resin.

### Maximum Ratings (T<sub>CASE</sub>=25°C)

Symbol	Val	l lm it		
Symbol	Min.	Max.	Unit	
PD		2300	mW	
IF		500	mA	
IFP		700	mA	
VF	not designed for	reverse operation	V	
R <sub>THJA</sub>		10	K/W	
$T_J$		120	°C	
T <sub>CASE</sub>	- 40	+ 100	°C	
T <sub>STG</sub>	- 40	+ 100	°C	
T <sub>SLD</sub>		+ 250	°C	
	IF IFP VF Rтнја TJ Tcase Tstg	SymbolMin. $P_D$ $I_F$ $I_F$ $I_{FP}$ $V_F$ not designed for $R_{THJA}$ $T_J$ $T_CASE$ - 40 $T_{STG}$ - 40	$P_D$ 2300 $I_F$ 500 $I_{FP}$ 700 $V_F$ not designed for reverse operation $R_{THJA}$ 10 $T_J$ 120 $T_{CASE}$ - 40 + 100 $T_{STG}$ - 40 + 100	

 $^{*1}$  duty=1%, pulse width = 10  $\mu s$   $^{*2}$  must be completed within 5 seconds

#### Electro-Optical Characteristics (T<sub>CASE</sub>=25°C)

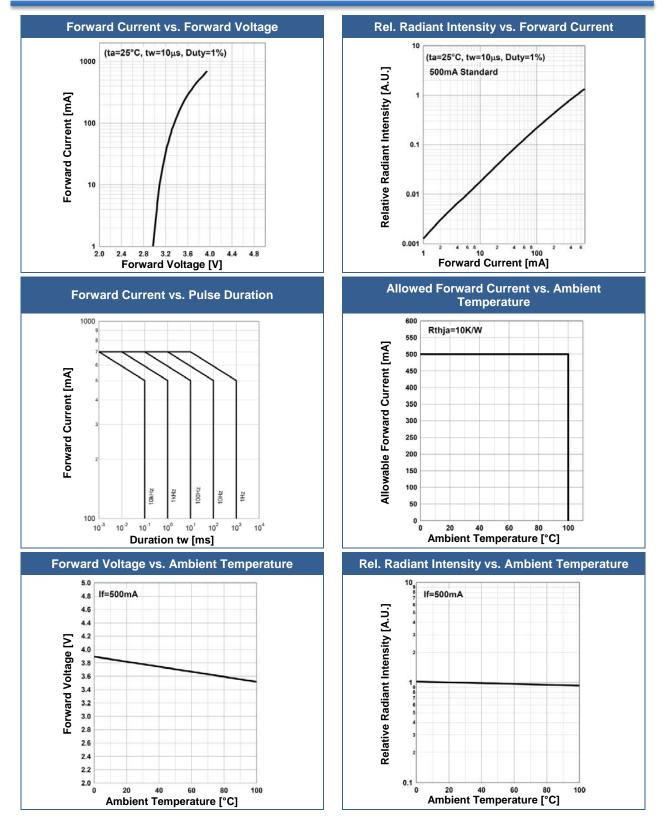
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	$\lambda_P$	I <sub>F</sub> =500mA	390	395	400	nm
Half Width	$\Delta \lambda$	I <sub>F</sub> =500mA		12		nm
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =500mA		3.8	4.5	V
	V <sub>FP</sub>	I <sub>FP</sub> =700mA		4.0		
Radiated Power *1	-	I <sub>F</sub> =500mA		750		mW
	Po	I <sub>FP</sub> =700mA		1000		
Viewing Angle	φ	I <sub>F</sub> =100mA		22		deg.
Rise Time	t <sub>R</sub>	I <sub>F</sub> =500mA		50		ns
Fall Time	t <sub>F</sub>	I <sub>F</sub> =500mA		55		ns

\*<sup>1</sup> measured by S3584-08

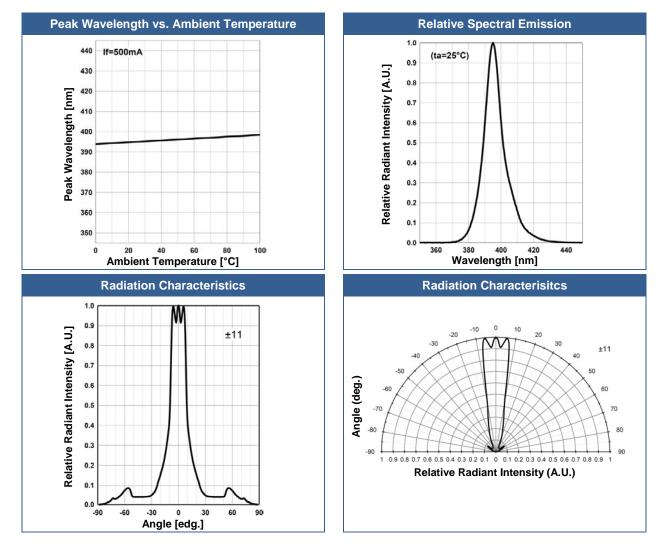
www.roithner-laser.com



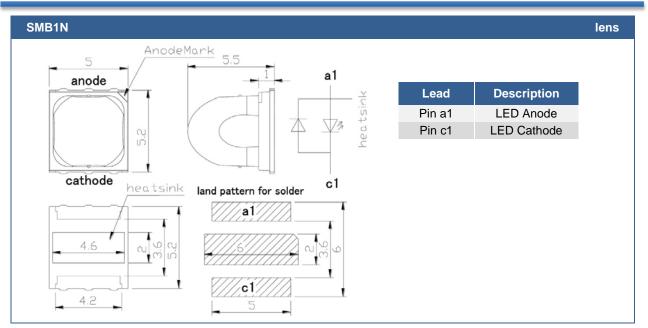
# Typical Performance Curves







# **Outline Dimensions**



All Dimensions in mm



### Precautions

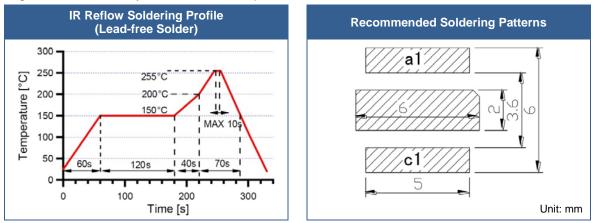
#### Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- · Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

#### **Recommended soldering conditions:**

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

#### **Cleaning:**

#### Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

#### Static Electricity:

**LEDs are sensitive to electrostatic discharge (ESD)**. Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

#### Radiation:

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

#### **Operation:**

#### Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

© All Rights Reserved

The above specifications are for reference purpose only and subjected to change without prior notice